

Data sheet acquired from Harris Semiconductor SCHS092C – Revised July 2003

CD4724B Types

CMOS 8-Bit Addressable Latch

High-Voltage Types (20-Volt Rating)

■ CD4724B 8-bit addressable latch is a serial-input, parallel-output storage register that can perform a variety of functions.

Data are inputted to a particular bit in the latch when that bit is addressed (by means of inputs AO, A1, A2) and when WRITE DISABLE is at a low level. When WRITE DISABLE is high, data entry is inhibited; however, all 8 outputs can be continuously read independent of WRITE DISABLE and address inputs.

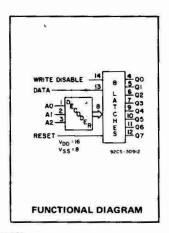
A master RESET input is available, which resets all bits to a logic "O" level when RESET and WRITE DISABLE are at a high level. When RESET is at a high level, and WRITE DISABLE is at a low level, the latch acts as a 1-of-8 demultiplexer; the bit that is addressed has an active output which follows the data input, while all unaddressed bits are held to a logic "O" level.

The CD4724B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Feature

- Selial date input
 Active parallel output
- Storage register capability
 Master clear
- Can function as demultiplexer
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V (full package-temperature range), 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) = 1 V at VDD = 5 V, 2 V at VDD = 10 V, 2.5 V at VDD = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

MANUFALINA DATINGS Absolute-Maximum Values:



Applications:

- Multi-line decoders
- A/D converters

MAXIMUM RATINGS, Absolute maximum values
DC SUPPLY-VOLTAGE RANGE, (VDD)
Voltages referenced to Voc Terminal)
MINIST YOUTAGE RANGE, ALL INPUTS
DC INPUT SURBENT, ANY ONE INPUT
DOWNED DISSIPATION PER PACKAGE (PD):
500mW
For Ta = +100°C to ±1025°C Derate Linearity at 12 mW/°C to 200 mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR
FOR TA = FILL PACKAGE-TEMPERATURE RANGE (All Package Types): 100mW
OPERATING-TEMPERATURE RANGE (TA)55°C to +125°C
STORAGE TEMPERATURE RANGE (Tstg)65°C to +150°C
STORAGE TEMPERATURE RANGE (1stg)
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/18 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max

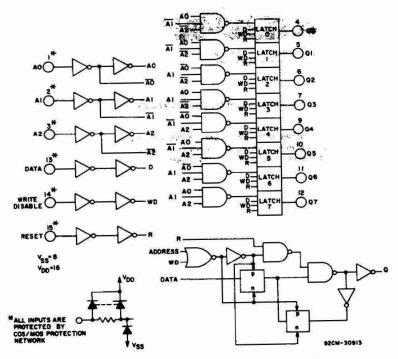
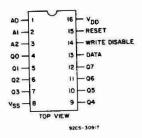


Fig. 1 - Logic diagram of CD47248 and detail of 1 of 8 latches.



TERMINAL ASSIGNMENT

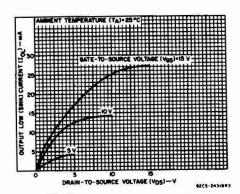


Fig. 2— Typical output low (sink) current characteristics.

RECOMMENDED OPERATING CONDITIONS at $T_A = 25^{\circ}$ C (Unless otherwise specified) For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	SEE	V _{DD}	LIM	ITS	UNITS	
	FIG. 15*	(V)	MIN.	MAX.	0	
Supply Voltage Range: (At T _A = Full Package Temperature Range)			3	18	٧	
Pulse Width, tw		5	200	-	*****	
Data	(4)	10	100	_		
		15	80			
	8	5	400	1	ns	
Address		10	200	1	""	
		15	125	_		
	T	5	150	-		
Reset	(5)	10	75			
		15	50	_		
Setup Time, t _S		5	100	_		
Data to WRITE DISABLE	(6)	10	50	_		
		15	35	_	ns	
Hold Time, t _H		5	150	_		
Data to WRITE DISABLE	7	10	75	_	ns	
		15	50	_		

*	Circled numbers	refer to time	s indicated on	master timing diagn	am

Note: In addition to the above characteristics, a WRITE DISABLE ON time (the time that WRITE DISABLE is at a high level) must be observed during an address change for the total time that the external address lines A0, A1, and A2 are settling to a stable level, to prevent a wrong cell from being addressed.

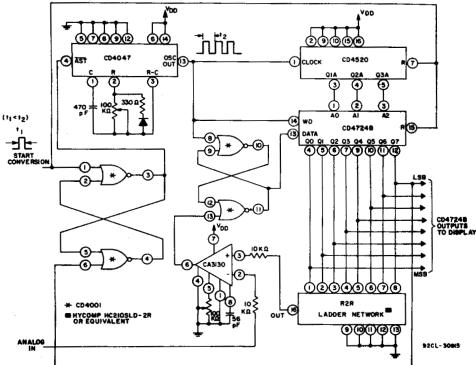
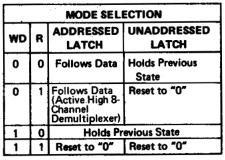


Fig. 5- A/D converter



WD - WRITE DISABLE

R = RESET

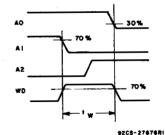


Fig. 3- Definition of WRITE DISABLE ON time.

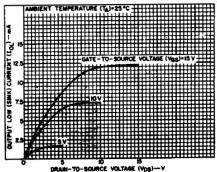


Fig. 4— Minimum output low (sink) current characteristics.

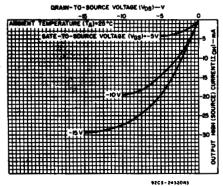
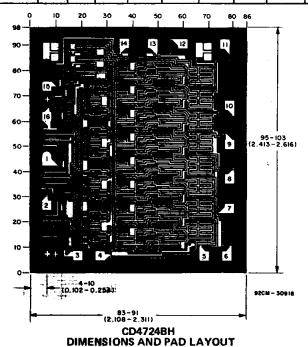


Fig.6 -- Typical output high (source) current characteristics.

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER-	COND	is	LIMITS AT INDICATED TEMPERATURES (°C)						UNITS		
ISTIC	٧o	VIN	VDD						+25		DIVITA
	(V).	(V)	(V)	-55	-40	+85	+125	Min.	Тур.	Max.	
Quiescent Device		0,5	5	5	5	150	150		0.04	5	
Current,		0,10	10	10	10	300	300		0.04	10	μА
IDD Max.	_	0,15	15	20	20	600	600	_	0.04	20	μ^
-		0,20	20	100	100	3000	3000	-	0.08	100	
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	- 1	
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	_]
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	34	6.8	ı	
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1		mA
(Source) Current,	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	- :	
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	_	
IOH Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-	
Output Voltage:	_	0,5	5		0	.05		_	0	0.05	
Low-Level, VOL Max.	-	0,10	10		0	.05		_	0	0.05	
VOL IMAX.	_	0,15	15	0.05				_	0	0.05	v
Output Voltage:	-]	0,5	5	4.95				4.95	5	_	
High-Level,	_	0,10	10		9	.95		9.95	10	-	
VOH Min.	-	0,15	15	14.95				14.95	15	_	
Input Low	0.5, 4.5	_	5		1	.5			—	1.5	
Voltage,	1, 9	-	10			3		_	T =	3	
VIL Max.	1.5,13.5	_	15			4		-	-	4	v
Input High	0.5, 4.5	_	5		;	3.5		3.5		_)
Voltage,	1, 9	-	10	7				7		[<u>-</u>]	
VIH Min.	1.5,13.5	-	15			11		11	_	-	<u> </u>
Input Current IIN Max.	-	0,18	18	±0.1	±0.1	±1	±1	_	±10 ⁻⁵	±0.1	μA



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

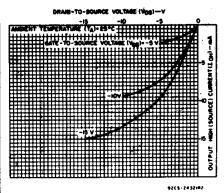


Fig.7 - Minimum output high (source) current characteristics.

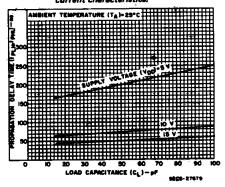


Fig. 8 — Typical propagation delay time (data to On) vs. load capacitance.

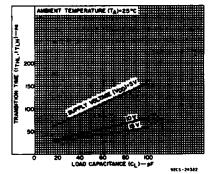


Fig. 9 — Typical transition time vs. load capacitance.

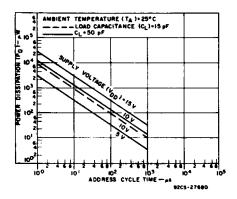


Fig. 10 — Typical dynamic power dissipation vs. address cycle time.

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25° C, C_L = 50 pF, Input t_r , t_f = 20 ns, R_L = 200 $K\Omega$

	CONDI	TIONS		NITS	
CHARACTERISTIC	SEE	V _{DD}	ALL PACE	AGE TYPES	UNITS
	Fig. 15*	(V)	TYP.	MAX.	
Propagation Delay: tpLH.		5	200	400	
^t PHL		10	75	150	
Data to Output,		15	50	100	
WRITE DISABLE		5	200	400	
to Output, _{tPLH} ,	2	10	80	160	ns
^t PHL	<u> </u>	15	60	120	
		5	175	350	
Reset to Output,	3	10	80	160	
tphl		15	65	130	
Address to Output,		5	225	450	
t _{PLH}	0	10	100	200	
^t PHL]	15	75	150	
Transition Time, t _{THL}		5	100	200	
(Any Output) tTLH		10	50	100	ns
		15	40	80	
Minimum Pulse		5	100	200	
Width, t _W	4	10	50	100	ns
Data		15	40	80	
		5	200	400	
Address	8	10	100	200	ns
		15	65	125	
		5	75	150	
Reset	5	10	40	75	ns
		15	25	50	
Minimum Setup		5	50	100	
Time, t _S	6	10	25	50	ns
Data to WRITE DISABLE		15	20	35	je.
Minimum Hold		5	75	150	
Time, t _H	①	10	40	75	ns
Data to WRITE DISABLE		15	25	50	
Input Capacitance, CIN	Any Int	out	5	7.5	ρF

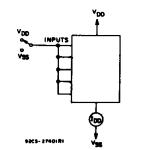


Fig. 11— Quiescent device current test circuit.

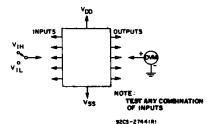


Fig. 12-Input voltage test circuit.

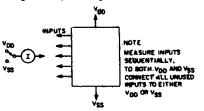


Fig. 13- Input current test circuit,

9205-27402

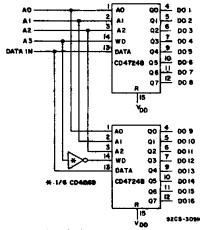


Fig. 14- 1 of 16 decoder/demultiplexer,

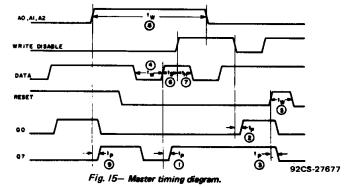


Fig 16— Multiple selection decoding — 4 x 4 crosspoint switch.

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
CD4724BE	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD4724BE	Samples
CD4724BF3A	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD4724BF3A	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF CD4724B, CD4724B-MIL:

Military : CD4724B-MIL

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
CD4724BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4724BE	N	PDIP	16	25	506	13.97	11230	4.32

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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